BLS9G2731L-400; BLS9G2731LS-400

LDMOS S-band radar power transistor

AMPLEON

Rev. 1 — 13 April 2017

Product data sheet

1. Product profile

1.1 General description

400 W LDMOS power transistor for S-band applications in the frequency range from 2700 MHz to 3100 MHz.

Table 1. Test information

Typical RF performance at T_{case} = 25 °C; t_p = 300 μs; δ = 10 %; I_{Dq} = 400 mA; in a class-AB demo circuit measured over the entire 2700 MHz to 3100 MHz frequency range.

Test signal	f	V_{DS}	P_L	G_p	η_D
	(MHz)	(V)	(W)	(dB)	(%)
pulsed RF	2700 to 3100	32	425	13	47

1.2 Features and benefits

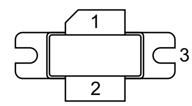
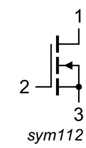
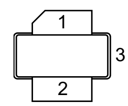
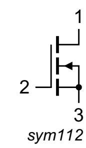
- High efficiency
- Excellent ruggedness
- Designed for S-band radar applications
- Excellent thermal stability
- Easy power control
- Integrated dual sided ESD protection enables excellent off-state isolation
- High flexibility with respect to pulse formats
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- S-band radar applications in the frequency range from 2700 MHz to 3100 MHz

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLS9G2731L-400 (SOT502A)			
1	drain		
2	gate		
3	source [1]		
BLS9G2731LS-400 (SOT502B)			
1	drain		
2	gate		
3	source [1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLS9G2731L-400	-	flanged ceramic package; 2 mounting holes; 2 leads	SOT502A
BLS9G2731LS-400	-	earless flanged ceramic package; 2 leads	SOT502B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		–6	+13	V
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$Z_{th(j-c)}$	transient thermal impedance from junction to case	T_{case} = 85 °C; P_L = 400 W		
		t_p = 100 μs; δ = 10 %	0.11	K/W
		t_p = 300 μs; δ = 10 %	0.15	K/W
		t_p = 500 μs; δ = 10 %	0.17	K/W
		t_p = 1000 μs; δ = 10 %	0.18	K/W

6. Characteristics

Table 6. DC characteristics

T_j = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 4.5 mA	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_D = 450 mA	1.5	1.9	2.5	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 32 V	-	-	4	μA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 3.75 V; V_{DS} = 10 V	-	85	-	A
I_{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	400	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 450 mA	-	4.2	-	S
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 3.75 V; I_D = 15.75 A	-	0.03	-	Ω

Table 7. RF characteristics

Test signal: pulsed RF; t_p = 300 μs; δ = 10 %; RF performance at V_{DS} = 32 V; I_{Dq} = 400 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production circuit measured at frequencies of 2700 MHz, 2900 MHz and 3100 MHz.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	P_L = 425 W	11	13	-	dB
RL_{in}	input return loss	P_L = 425 W	-	−7	-	dB
η_D	drain efficiency	P_L = 425 W	44	47	-	%
$P_{droop(pulse)}$	pulse droop power	P_L = 425 W	-	0.0	0.3	dB
t_r	rise time	P_L = 425 W	-	6	50	ns
t_f	fall time	P_L = 425 W	-	6	50	ns
$P_{L(3dB)}$	output power at 3 dB gain compression		400	-	-	W

7. Test information

7.1 Ruggedness in class-AB operation

The BLS9G2731L-400 and BLS9G2731LS-400 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 100 mA; P_L = 400 W; t_p = 300 μs; δ = 10 %.

7.2 Impedance information

Table 8. Typical impedance

f	Z_S	Z_L
(MHz)	(Ω)	(Ω)
2700	1.6 – j5.8	1.6 – j3.7
2800	2.9 – j6.6	1.8 – j3.6
2900	8.0 – j4.7	2.2 – j3.1
3000	4.4 – j0.3	1.9 – j2.4
3100	1.9 – j0.7	1.5 – j2.1

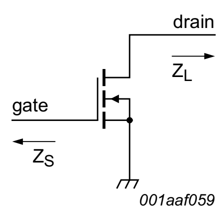
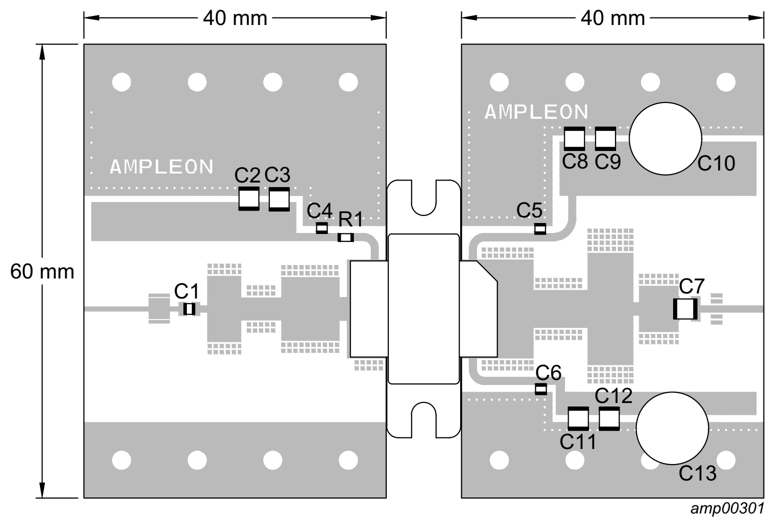


Fig 1. Definition of transistor impedance

7.3 Test circuit



Printed-Circuit Board (PCB): Rogers 4360G2; thickness = 0.61 mm; ε_r = 6.15, Cu = 35 μm.

See Table 9 for a list of components.

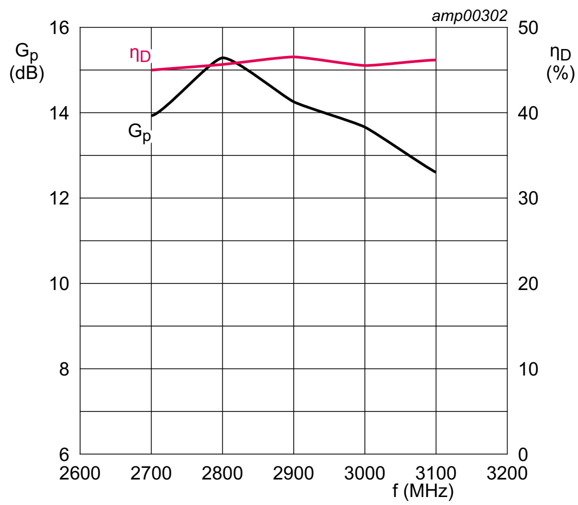
Fig 2. Component layout

Table 9. List of components

See Figure 2 for component layout.

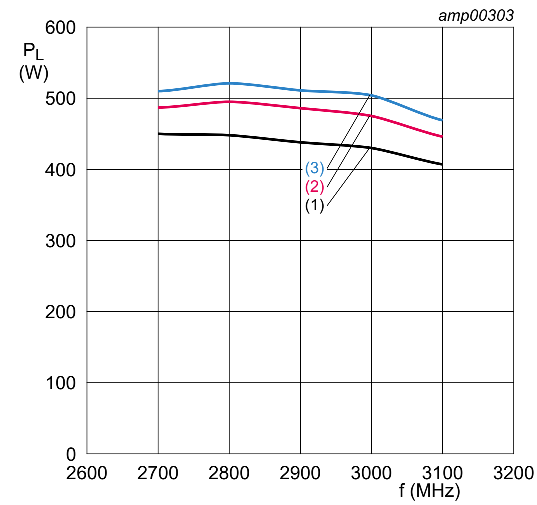
Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	12 pF	ATC 800A
C2, C8, C11	multilayer ceramic chip capacitor	1 nF	ATC 800B
C3, C9, C12	multilayer ceramic chip capacitor	10 μF	Murata: GRM55DR61H106KA88L
C4, C5, C6	multilayer ceramic chip capacitor	15 pF	ATC 800A
C7	multilayer ceramic chip capacitor	33 pF	ATC 800B
C10, C13	electrolytic capacitor	100 μF, 63 V	
R1	resistor	5 Ω	SMD 0603

7.4 Graphical data



V_{DS} = 32 V; I_{Dq} = 400 mA; P_L = 425 W; t_p = 300 μs; δ = 10 %.

Fig 3. Power gain and drain efficiency as function of frequency; typical values



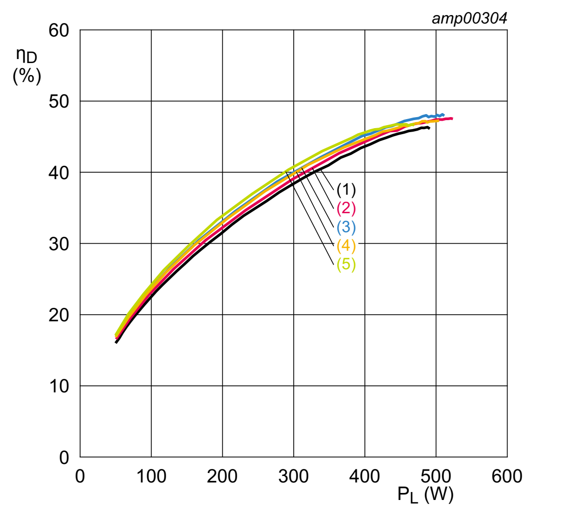
V_{DS} = 32 V; I_{Dq} = 400 mA; t_p = 300 μs; δ = 10 %.

(1) P_{1dB}

(2) P_{2dB}

(3) P_{3dB}

Fig 4. Output power as a function of frequency; typical values



V_{DS} = 32 V; I_{Dq} = 400 mA; t_p = 300 μs; δ = 10 %.

(1) f = 2700 MHz

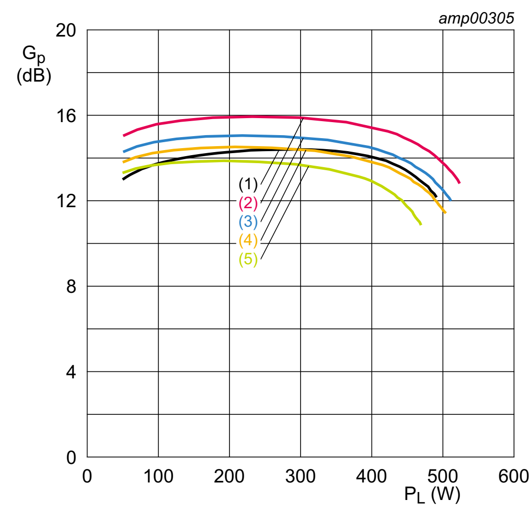
(2) f = 2800 MHz

(3) f = 2900 MHz

(4) f = 3000 MHz

(5) f = 3100 MHz

Fig 5. Drain efficiency as a function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 400 mA; t_p = 300 μs; δ = 10 %.

(1) f = 2700 MHz

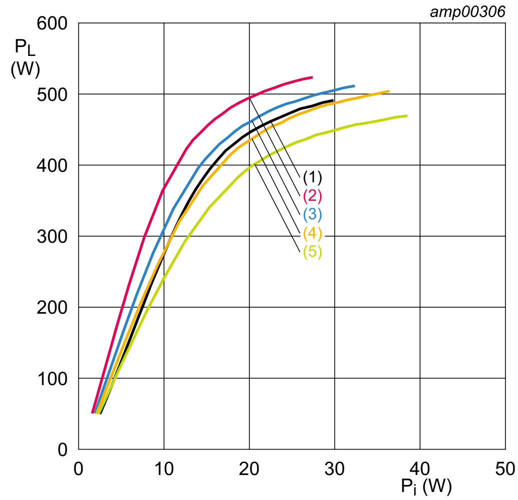
(2) f = 2800 MHz

(3) f = 2900 MHz

(4) f = 3000 MHz

(5) f = 3100 MHz

Fig 6. Power gain as a function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 400 mA; t_p = 300 μs; δ = 10 %.

(1) f = 2700 MHz

(2) f = 2800 MHz

(3) f = 2900 MHz

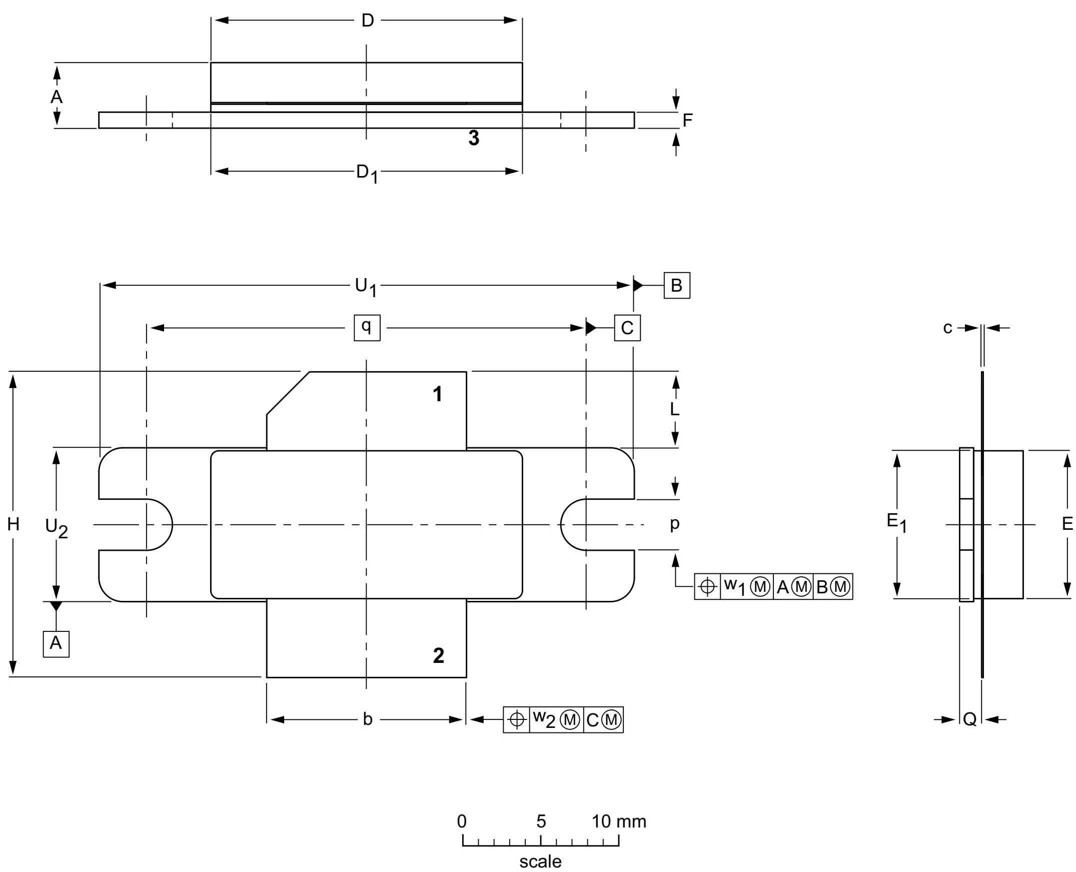
(4) f = 3000 MHz

(5) f = 3100 MHz

Fig 7. Output power as a function of input power; typical values

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads **SOT502A**



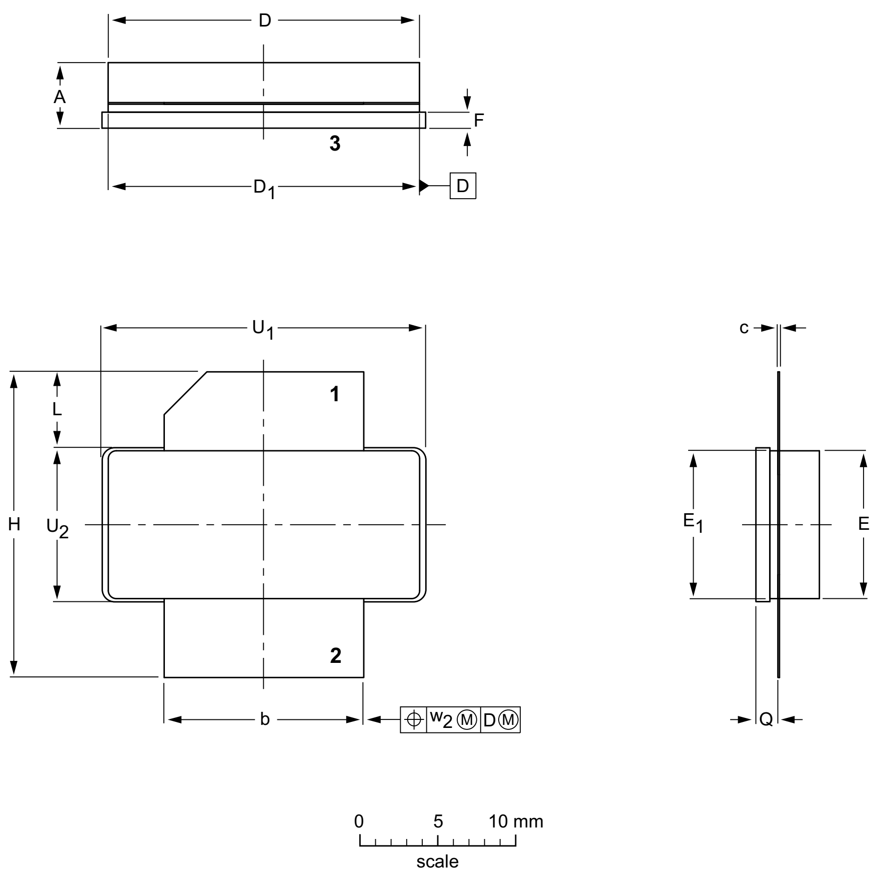
DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D_1	E	E_1	F	H	L	p	Q	q	U_1	U_2	w_1	w_2
mm	4.72 3.43	12.83 12.57	0.15 0.08	20.02 19.61	19.96 19.66	9.50 9.30	9.53 9.25	1.14 0.89	19.94 18.92	5.33 4.32	3.38 3.12	1.70 1.45	27.94	34.16 33.91	9.91 9.65	0.25	0.51
inches	0.186 0.135	0.505 0.495	0.006 0.003	0.788 0.772	0.786 0.774	0.374 0.366	0.375 0.364	0.045 0.035	0.785 0.745	0.210 0.170	0.133 0.123	0.067 0.057	1.100	1.345 1.335	0.390 0.380	0.01	0.02

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT502A						~~03-01-10~~ 12-05-02

Fig 8. Package outline SOT502A

Earless flanged ceramic package; 2 leads **SOT502B**



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D_1	E	E_1	F	H	L	Q	U_1	U_2	w_2
mm	4.72 3.43	12.83 12.57	0.15 0.08	20.02 19.61	19.96 19.66	9.50 9.30	9.53 9.25	1.14 0.89	19.94 18.92	5.33 4.32	1.70 1.45	20.70 20.45	9.91 9.65	0.25
inches	0.186 0.135	0.505 0.495	0.006 0.003	0.788 0.772	0.786 0.774	0.374 0.366	0.375 0.364	0.045 0.035	0.785 0.745	0.210 0.170	0.067 0.057	0.815 0.805	0.390 0.380	0.010

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT502B						~~07-05-09~~ 12-05-02

Fig 9. Package outline SOT502B

9. Handling information

CAUTION	
	This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	2 [2]

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V, but fails after exposure to an ESD pulse of 750 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

10. Abbreviations

Table 11. Abbreviations

Acronym	Description
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
S-band	Short wave band
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLS9G2731L-400_LS-400 v.1	20170413	Product data sheet		-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term ‘short data sheet’ is explained in section “Definitions”.

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14. Contents

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